TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC7SZ08AFE

#### 2 Input AND Gate

#### **Features**

• High output drive: ±24 mA (typ.)

 $@V_{CC} = 3 V$ 

• Super high speed operation: tPD 2.7 ns (typ.)

 $@V_{CC} = 5 \text{ V}, 50 \text{ pF}$ 

• Operation voltage range:  $V_{CC (opr)} = 1.8 \sim 5.5 \text{ V}$ 

• Supply voltage data retention:  $V_{CC} = 1.5 \sim 5.5 \text{ V}$ 

• Latch-up performance: ±500 mA

• ESD performance: Human body model  $> \pm 2000 \text{ V}$ 

Machine model  $> \pm 200 \text{ V}$ 

Power down protection is provided on all inputs.

ullet Matches the performance of TC74LCX series when operated at 3.3 V VCC

• Input rise and fall time (tr, tf) (recommended operation condition)

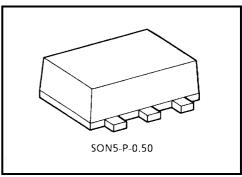
@Vcc = 1.8 V, 2.5 V  $\pm$  0.2 V: 0~20 ns/V

 $@V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}: 0 \sim 10 \text{ ns/V}$ 

 $@V_{CC} = 5.5 \text{ V} \pm 0.5 \text{ V}: 0 \sim 5 \text{ ns/V}$ 

### **Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5~6	V
DC input voltage	V <sub>IN</sub>	-0.5~6	V
DC output voltage	V <sub>OUT</sub>	-0.5~V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	150	mW
Storage temperature	T <sub>stg</sub>	-65~150	°C
Lead temperature (10 s)	TL	260	°C



Weight: 0.003 g (typ.)

# **Electrical Characteristics**

#### **DC Characteristics**

OL Test		Test				Ta = 25°C			Ta = -40~85°C		
Characteristics	Symbol	Circuit	Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Unit
High-level input					1.8	0.75 × V <sub>CC</sub>			0.75 × V <sub>CC</sub>		V
voltage	V <sub>IH</sub>			_		0.7 × V <sub>CC</sub>	_	_	0.7 × V <sub>CC</sub>	_	V
Low-level input					1.8	_	_	0.25 × V <sub>CC</sub>	_	0.25 × V <sub>CC</sub>	
voltage				_	2.3- 5.5	_	_	0.3 × V <sub>CC</sub>	_	0.3 × V <sub>CC</sub>	V
					1.8	1.7	1.8	_	1.7	_	V
				Jour = 100A	2.3	2.2	2.3	_	2.2	_	
				$I_{OH} = -100 \mu A$	3.0	2.9	3.0		2.9	_	
High-level	High-level output voltage VOH —		V <sub>IN</sub> = V <sub>IH</sub>		4.5	4.4	4.5		4.4	_	
output voltage				$I_{OH} = -8 \text{ mA}$	2.3	1.9	2.15		1.9		
				I <sub>OH</sub> = -16 mA	3.0	2.4	2.8		2.4		
				I <sub>OH</sub> = -24 mA	3.0	2.3	2.68		2.3	_	
				$I_{OH} = -32 \text{ mA}$	4.5	3.8	4.2	_	3.8	_	
					1.8	—	0	0.1	_	0.1	
			I <sub>OL</sub> = 100 μA	2.3		0	0.1	_	0.1	-	
				3.0	_	0	0.1	_	0.1		
Low-level output	Low-level output VOL —		V <sub>IN</sub> = V <sub>IH</sub> or		4.5	_	0	0.1	_	0.1	V
voltage			VIL	$I_{OL} = 8 \text{ mA}$	2.3		0.1	0.3		0.3	
			I <sub>OL</sub> = 16 mA	3.0		0.15	0.4		0.4		
			I <sub>OL</sub> = 24 mA	3.0		0.22	0.55		0.55		
				I <sub>OL</sub> = 32 mA	4.5		0.22	0.55		0.55	
Input leakage current	I <sub>IN</sub>		V <sub>IN</sub> = 5.5 V or GND		0- 5.5		_	±1	_	±10	μА
Quiescent supply current	I <sub>CC</sub>		V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	2	_	20	μА

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# AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

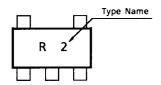
Characteristics Symbol		Test Circuit	Test Condition		Ta = 25°C			Ta = -40~85°C		Unit
Characteristics Symbol	V <sub>CC</sub> (V)			Min	Тур.	Max	Min	Max	Unit	
			$\begin{split} C_L &= 15 \text{ pF,} \\ R_L &= 1 \text{ M}\Omega \end{split}$	1.8	2.0	5.2	9.5	2.0	10.5	- ns
				$2.5\pm0.2$	8.0	3.4	7.0	0.8	7.5	
Propagation delay				$3.3 \pm 0.3$	0.5	2.6	4.7	0.5	5.0	
time				5.0 ± 0.5	0.5	2.2	4.1	0.5	4.4	
			$C_L = 50 \text{ pF},$ $R_L = 500 \Omega$	$3.3 \pm 0.3$	1.5	3.3	5.2	1.5	5.5	
				5.0 ± 0.5	0.8	2.7	4.5	0.8	4.8	
Input capacitance	C <sub>IN</sub>		_	0-5.5	_	4	_	_	_	pF
Power dissipation capacitance C <sub>f</sub>	0		(Note)	3.3	_	19	_	_	_	- pF
	OPD	C <sub>PD</sub> —		5.5	_	26		_	_	

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

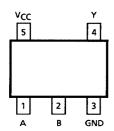
Average operating current can be obtained by the equation.

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

# Marking



# Pin Assignment (top view)



#### **Truth Table**

Α	В	Υ
L	L	L
L	Н	L
Н	L	L
Н	Н	Н

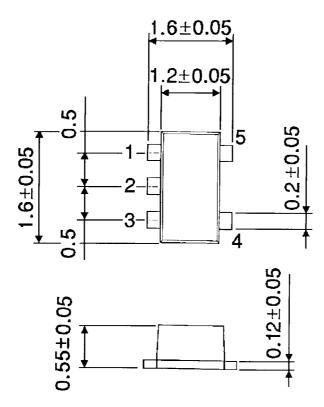
#### **Logic Diagram**



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# **Package Dimensions**

SON5-P-0.50 Unit: mm



Weight: 0.003 g (typ.)

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